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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: William C. Phillips; Mark E. Confirmation No. 9345  
Schommer; John W. Forsberg;  
Alex C. Toy; David P. Olson

Serial No.: 10/693,006

Filed: October 24, 2003 Customer No.: 28863

Examiner: Unknown

Group Art Unit: 3736 Docket No.: 1023-290US01

Title: MEDICAL DEVICE PROGRAMMER WITH FACEPLATE

CERTIFICATE UNDER 37 CFR 1.8: I hereby certify that this correspondence is being deposited with the United States Post Service, as First Class Mail, in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on October 8, 2004.

By: Shirley A. Betlach  
Name: Shirley A. Betlach

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Applicant submits the references listed on the attached form PTO-1449. This statement is being filed, to the best of Applicant's knowledge, before the receipt of a first Office Action on the merits.

Applicant has enclosed a copy of each article cited and each foreign document cited. Copies of the U.S. patents are not enclosed.

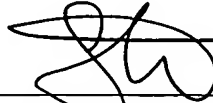
English language abstracts are provided for all non-English language references, except DE 203 10 991 U1. For that reference, Applicant provides a concise explanation of relevance.

In particular, based on Applicant's understanding, the DE 203 10 991 U1 reference describes a portable electrical stimulator for stimulating a hand that holds the stimulator. The stimulator includes two external electrodes, coupled to an electrical circuit within the stimulator, for delivering stimulation energy.

Respectfully submitted,

Date: \_\_\_\_\_

10-8-04



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| <b>Form 1449*</b><br><b>INFORMATION DISCLOSURE<br/>STATEMENT</b><br><b>IN AN APPLICATION</b><br>(Use several sheets if necessary) | <b>Docket Number:</b><br>1023-290US01   | <b>Application Number:</b><br>10/693,006 |
|   | <b>Applicant:</b><br>William C. Phillips; Mark E. Schommer; John W. Forsberg; Alex C. Toy; David P. Olson |  |
|   | <b>Filing Date:</b><br>October 24, 2003   | <b>Group Art Unit:</b><br>3736           |

**U.S. PATENT DOCUMENTS**

| Examiner Initial | Document Number | Issue/Document Publication Date | Name               | Filing Date If Appropriate |
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**FOREIGN PATENT DOCUMENTS**

| Examiner Initial | Document Number | Publication Date | Country                             | Translation |    |
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|                  |                 |                  |                                     | Yes         | No |
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|                  | 203 10 991 U1   | 01/15/2004       | Germany (English Language Abstract) |             |    |
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|  | Notification of Transmittal of the International Search Report and the Written Opinion of the International Searching Authority, or the Declaration for International Application No. PCT/US2004/002452, filed January 28, 2004. |
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|                 |                        |
|-----------------|------------------------|
| <b>EXAMINER</b> | <b>Date Considered</b> |
|-----------------|------------------------|

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.